



**12500 TI Boulevard, MS 8640, Dallas, Texas 75243**

**Notification# 20180717001  
Datasheet for OPA354A-Q1, OPA2354A-Q1, OPA4354-Q1  
Information Only**

**Date:** July 17, 2018  
**To:** MOUSER PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager ([PCN\\_ww\\_admin\\_team@list.ti.com](mailto:PCN_ww_admin_team@list.ti.com)).

Sincerely,

PCN Team  
SC Business Services

**Information Only  
Attachments**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

<b>DEVICE</b>	<b>CUSTOMER PART NUMBER</b>
OPA2354AQDGKRQ1	null
OPA354AQDBVRQ1	null
OPA4354AQPWRQ1	null

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20180717001	<b>PCN Date:</b>	July 17, 2018
<b>Title:</b>	Datasheet for OPA354A-Q1, OPA2354A-Q1, OPA4354-Q1		
<b>Customer Contact:</b>	<a href="#">PCN Manager</a>		<b>Dept:</b> Quality Services
<b>Change Type:</b>			
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site	
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process	
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials	
		<input type="checkbox"/> Wafer Fab Process	

## Notification Details

### Description of Change:

Texas Instruments Incorporated is announcing an information only notification.

The product datasheet(s) is being updated as summarized below.

The following change history provides further details.



**OPA354A-Q1, OPA2354A-Q1, OPA4354-Q1**

SBOS492F – JUNE 2009 – REVISED MAY 2018

### Changes from Revision E (August 2016) to Revision F

Page

- Deleted table note about input terminals and input signals from *Absolute Maximum Ratings* table ..... 6

The datasheet number will be changing.

Device Family	Change From:	Change To:
OPA354A-Q1, OPA2354A-Q1, OPA4354-Q1	SBOS492E	SBOS492F

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/OPA354A-Q1>

### Reason for Change:

To accurately reflect device characteristics.

### Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.

### Changes to product identification resulting from this PCN:

None.

### Product Affected:

OPA2354AQDGKRQ1	OPA354AQDBVRQ1	OPA4354AQPWRQ1	
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For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	<a href="mailto:PCNAmericasContact@list.ti.com">PCNAmericasContact@list.ti.com</a>
Europe	<a href="mailto:PCNEuropeContact@list.ti.com">PCNEuropeContact@list.ti.com</a>
Asia Pacific	<a href="mailto:PCNAsiaContact@list.ti.com">PCNAsiaContact@list.ti.com</a>
Japan	<a href="mailto:PCNJapanContact@list.ti.com">PCNJapanContact@list.ti.com</a>